



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

2SA1708 / 2SC4488 — PNP / NPN Epitaxial Planar Silicon Transistor High-Voltage Switching Applications

Features

- Adoption of FBET, MBIT processes
- High breakdown voltage, large current capacity
- Fast switching speed

()2SA1708

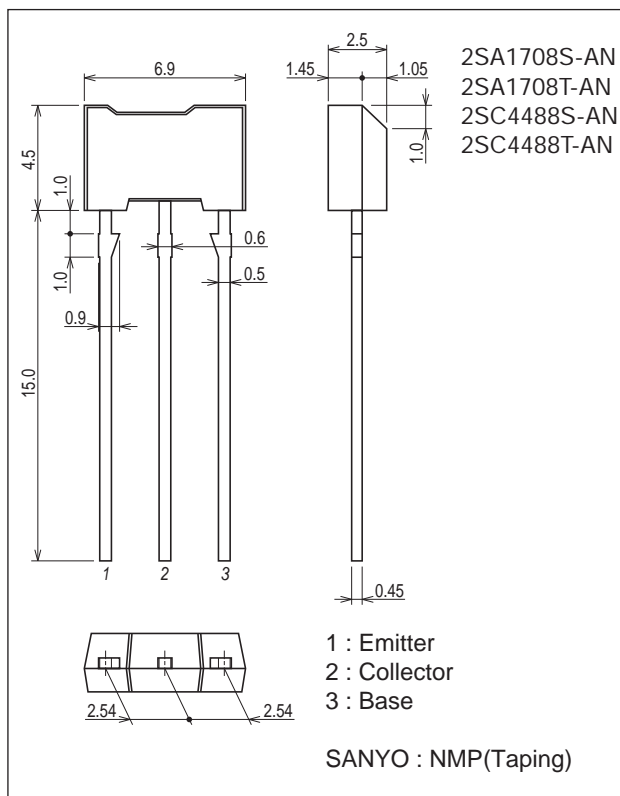
Specifications

Absolute Maximum Ratings at Ta=25°C

| Parameter | Symbol | Conditions | Ratings | Unit |
|------------------------------|--------|------------|-------------|------|
| Collector-to-Base Voltage | VCBO | | (-)120 | V |
| Collector-to-Emitter Voltage | VCEO | | (-)100 | V |
| Emitter-to-Base Voltage | VEBO | | (-)6 | V |
| Collector Current | IC | | (-)1 | A |
| Collector Current (Pulse) | ICP | | (-)2 | A |
| Collector Dissipation | PC | | 1 | W |
| Junction Temperature | Tj | | 150 | °C |
| Storage Temperature | Tstg | | -55 to +150 | °C |

Package Dimensions

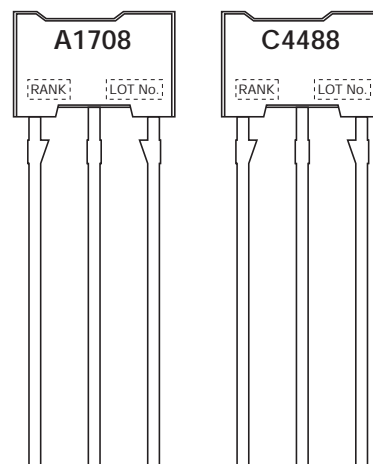
unit : mm (typ)
7540-001



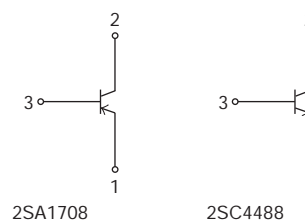
Product & Package Information

- Package : NMP(Taping)
- JEITA, JEDEC : SC-71
- Minimum Packing Quantity : 2,500 pcs./box

Marking(NMP(Taping))



Electrical Connection



SANYO Semiconductor Co., Ltd.

<http://www.sanyosemi.com/en/network/>

2SA1708 / 2SC4488

Electrical Characteristics at Ta=25°C

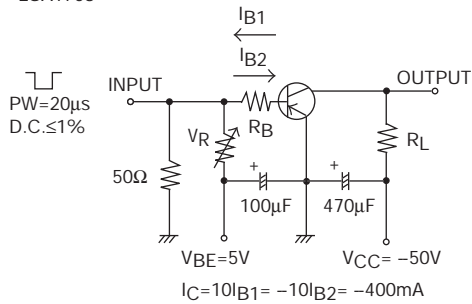
| Parameter | Symbol | Conditions | Ratings | | | Unit |
|-----------------------------------------|---------------|-------------------------------|---------|-----------|-----------|------|
| | | | min | typ | max | |
| Collector Cutoff Current | I_{CBO} | $V_{CB}=(-)100V, I_E=0A$ | | | (-)100 | nA |
| Emitter Cutoff Current | I_{EBO} | $V_{EB}=(-)4V, I_C=0A$ | | | (-)100 | nA |
| DC Current Gain | h_{FE} | $V_{CE}=(-)5V, I_C=(-)100mA$ | 140* | | 400* | |
| Gain-Bandwidth Product | f_T | $V_{CE}=(-)10V, I_C=(-)100mA$ | | 120 | | MHz |
| Output Capacitance | C_{ob} | $V_{CB}=(-)10V, f=1MHz$ | | (13)8.5 | | pF |
| Collector-to-Emitter Saturation Voltage | $V_{CE(sat)}$ | $I_C=(-)400mA, I_B=(-)40mA$ | | (-0.2)0.1 | (-0.6)0.4 | V |
| Base-to-Emitter Saturation Voltage | $V_{BE(sat)}$ | | | (-)0.85 | (-)1.2 | V |
| Collector-to-Base Breakdown Voltage | $V_{(BR)CBO}$ | $I_C=(-)10\mu A, I_E=0A$ | (-)120 | | | V |
| Collector-to-Emitter Breakdown Voltage | $V_{(BR)CEO}$ | $I_C=(-)1mA, R_{BE}=\infty$ | (-)100 | | | V |
| Emitter-to-Base Breakdown Voltage | $V_{(BR)EBO}$ | $I_E=(-)10\mu A, I_C=0A$ | (-)6 | | | V |
| Turn-ON Time | t_{on} | See specified Test Circuit. | | (80)80 | | ns |
| Storage Time | t_{stg} | | | (700)850 | | ns |
| Fall Time | t_f | | | (40)50 | | ns |

* : The 2SA1708/2SC4488 are classified by 100mA h_{FE} as follows :

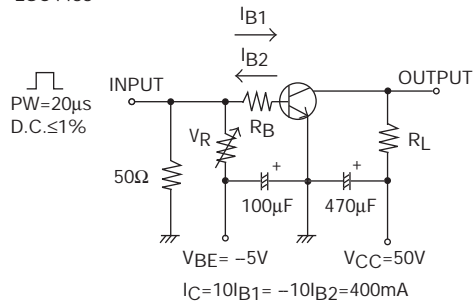
| Rank | S | T |
|----------|------------|------------|
| h_{FE} | 140 to 280 | 200 to 400 |

Switching Time Test Circuit

2SA1708

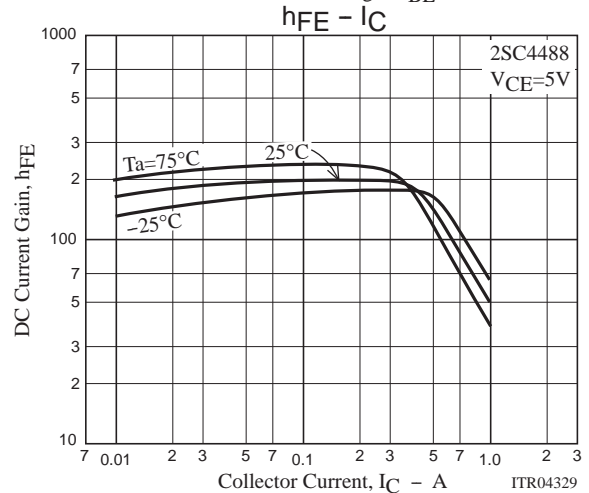
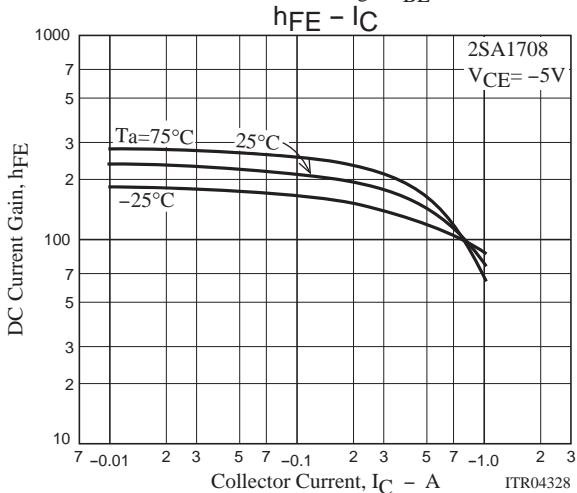
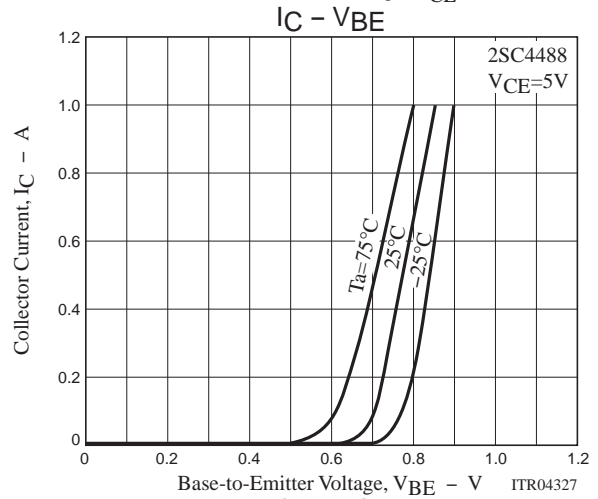
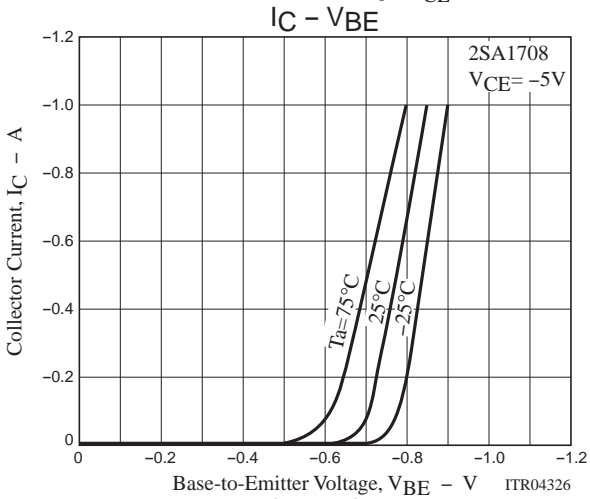
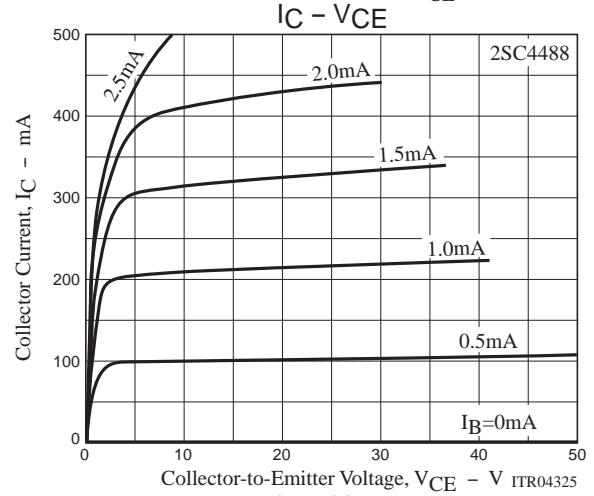
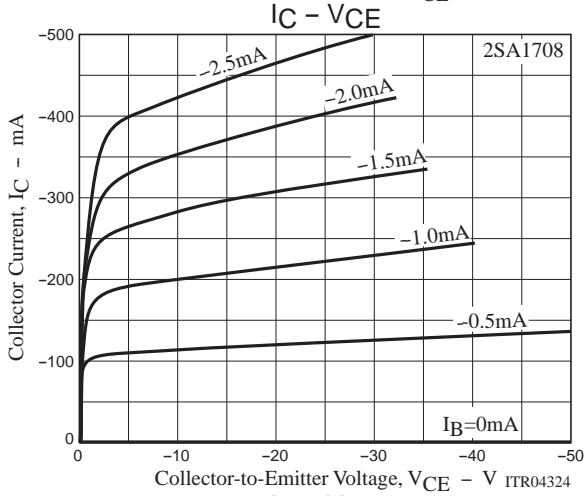
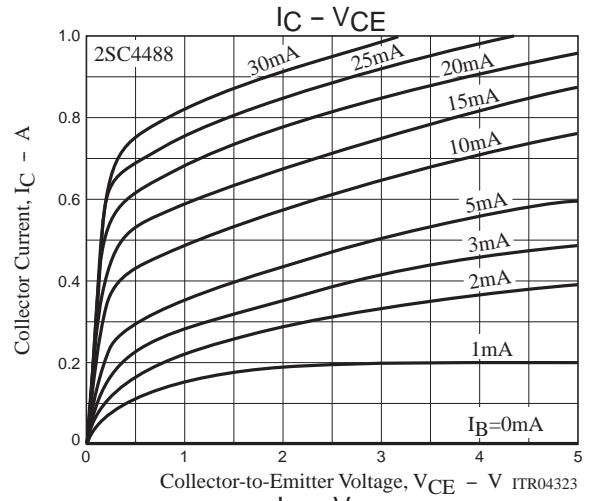
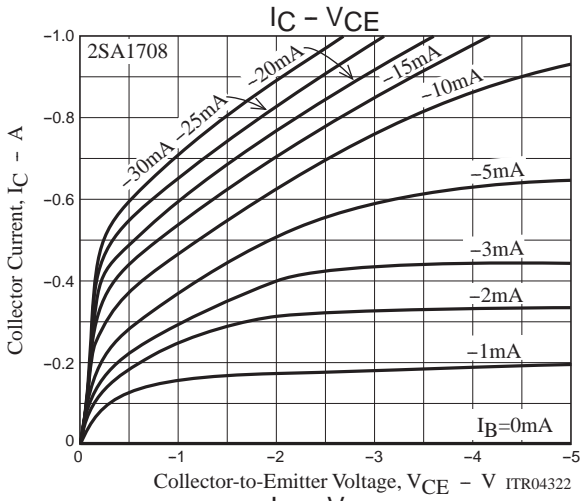


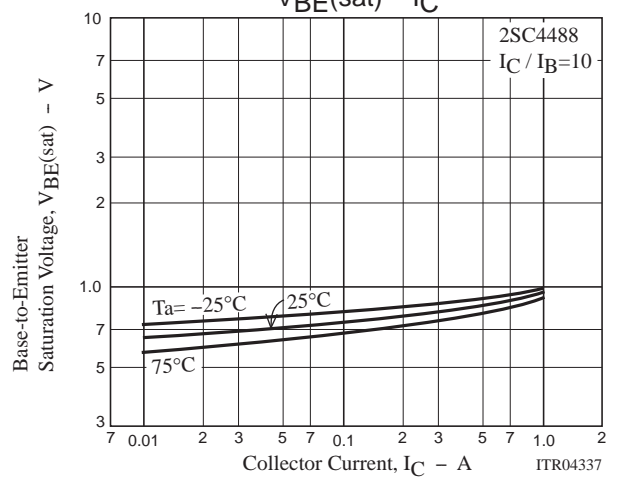
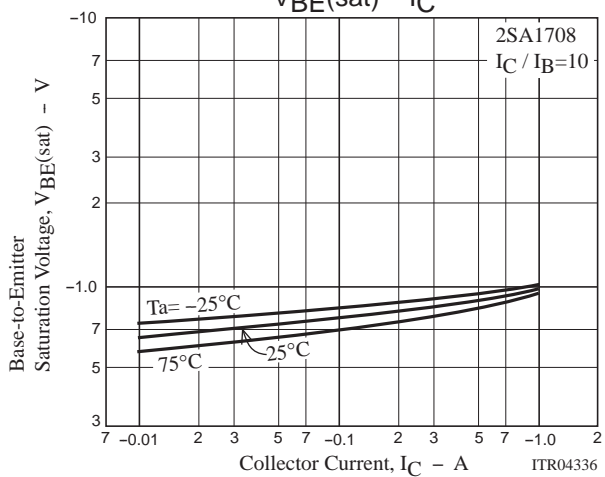
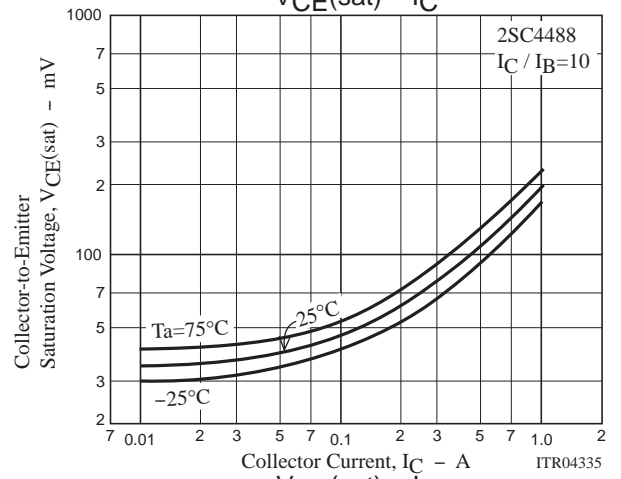
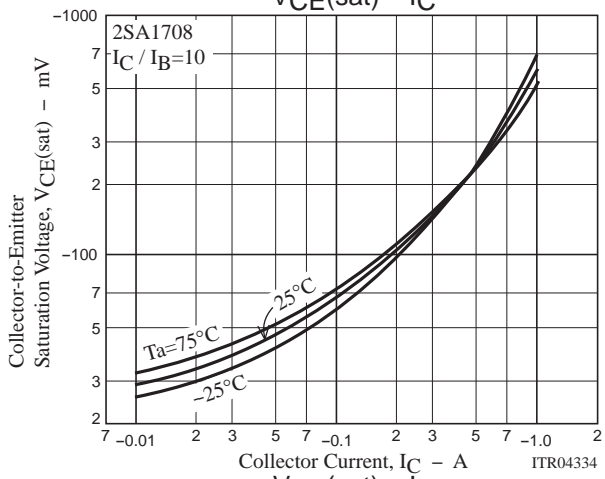
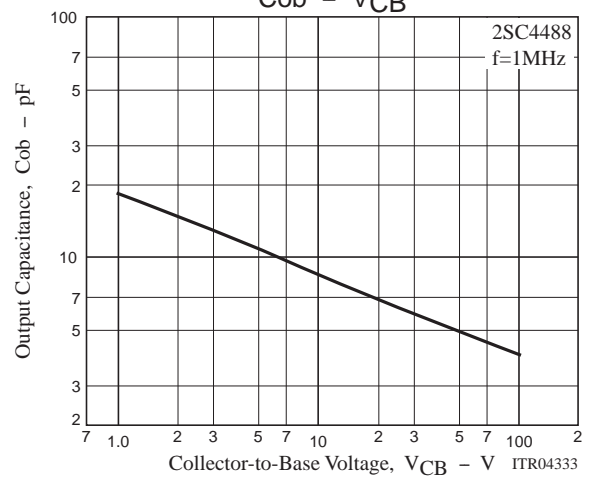
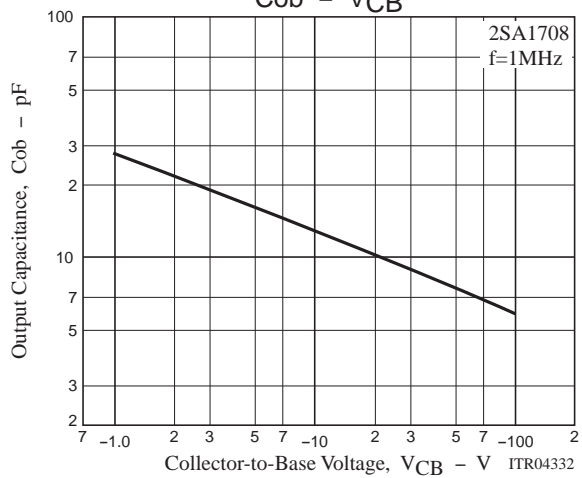
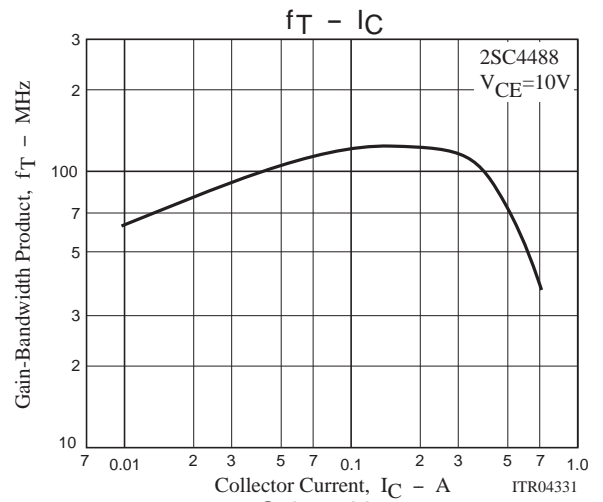
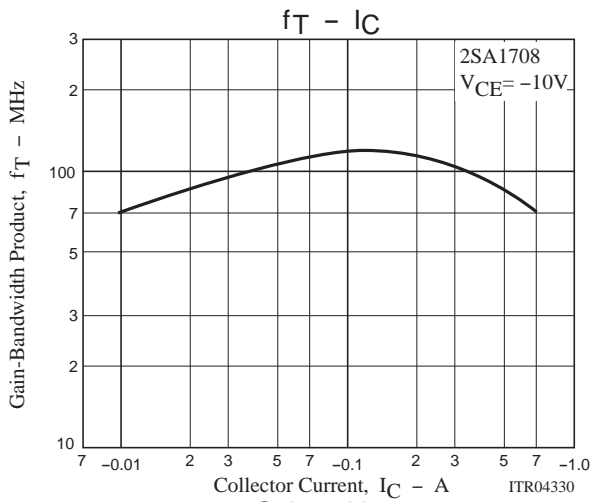
2SC4488



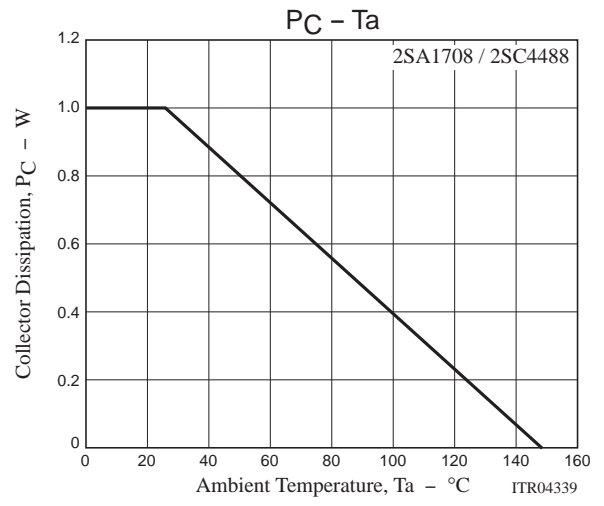
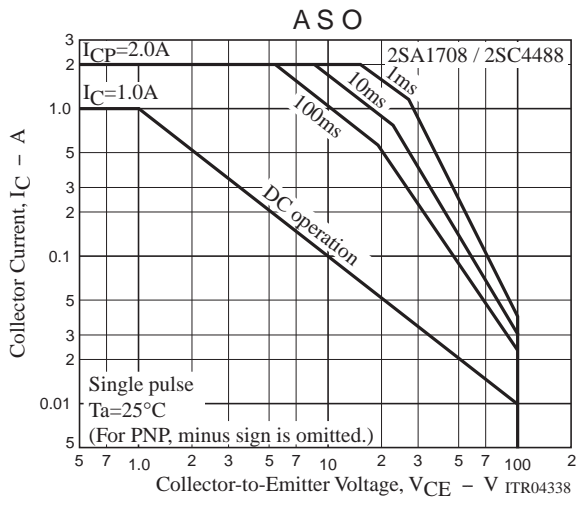
Ordering Information

| Device | Package | Shipping | memo |
|-------------|-------------|---------------|---------|
| 2SA1708S-AN | NMP(Taping) | 2,500pcs./box | Pb Free |
| 2SA1708T-AN | NMP(Taping) | 2,500pcs./box | |
| 2SC4488S-AN | NMP(Taping) | 2,500pcs./box | |
| 2SC4488T-AN | NMP(Taping) | 2,500pcs./box | |





2SA1708 / 2SC4488



Bag Packing Specification

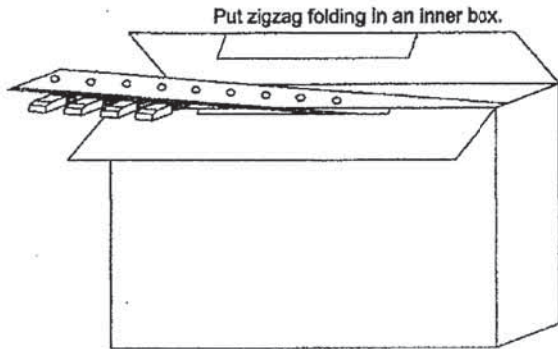
2SA1708S-AN, 2SA1708T-AN, 2SC4488S-AN, 2SC4488T-AN

NMP (Zigzag folding)

| Storage package Outline name | Package type | Maximum Number of devices contained (pcs.) | | Packing format | |
|------------------------------|--------------|---------------------------------------------------------|------------------|-----------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|
| | | Inner box No. | Storage quantity | Outer box (C-6) | Outer box (C-8) |
| NMP | AN/AZ | C-3 Inner box Dimensions :mm(external) 330×45×125 | 2,500 | 8 inner boxes contained(20,000pcs.) Outer box Dimensions:mm(external) 585×345×195 | 4 inner boxes contained(10,000pcs.) Outer box Dimensions:mm(external) 345×300×195 |

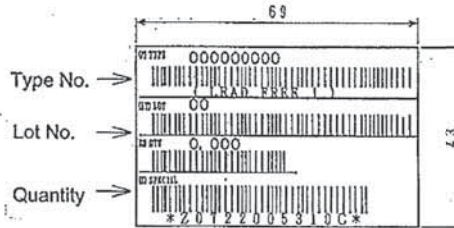
1. Packing format

Packing method



2. Bar code label

(Unit : mm)

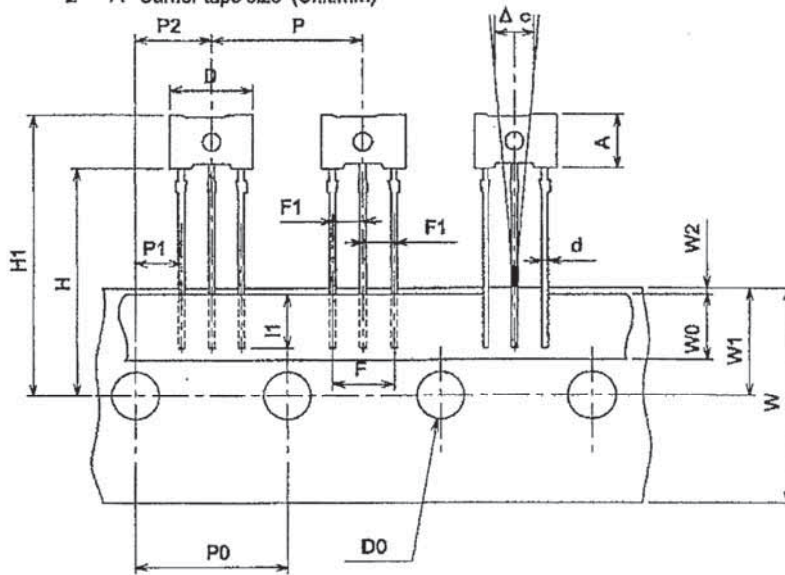


*LEAD FREE 1:

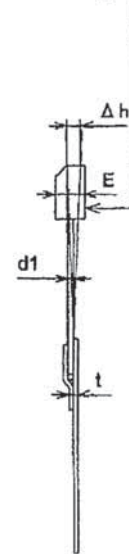
Lead-free External terminal surface treatment product.

2. Taping specifications

2-1. Carrier tape size (Unit:mm)



Marking surface



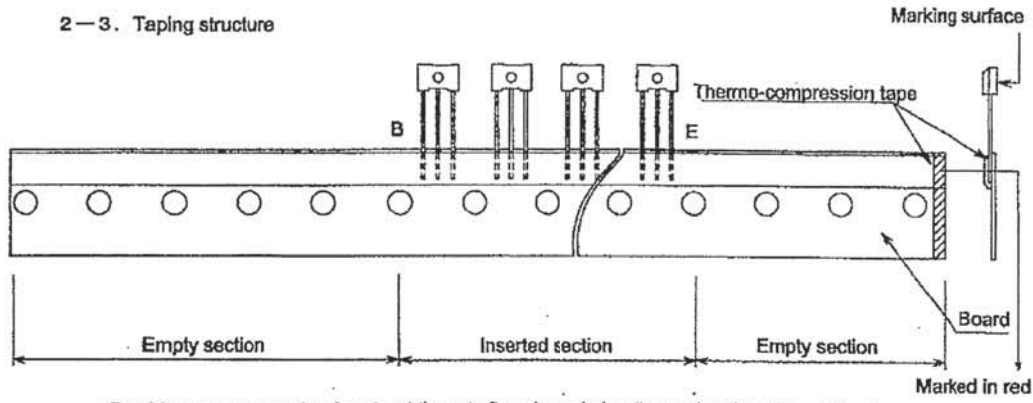
2-2. Taping size standard

| Item | Symbol | Standard | Tolerance |
|---------------------------------|--------|----------|--------------|
| Work piece outside diameter | D | 6.9 | ±0.2 |
| | E | 2.5 | ±0.2 |
| Work piece height | A | 4.5 | ±0.2 |
| Lead wire diameter | d | 0.5 | ±0.1 |
| Lead wire thickness | d1 | 0.45 | ±0.1 |
| Bonded lead wire | I1 | 3.0MIN | |
| Pitch between products | P | 12.7 | ±0.5 |
| Pitch between perforations | P0 | 12.7 | ±0.2 |
| Total pitch for 21 perforations | P0×20 | 254.0 | ±1.0 |
| Distance between lead wire | F | 5.0 | +0.8 -0.2 |
| Lead wire pitch distance | F1 | 2.54 | +0.4 -0.1 |
| Displacement of perforations | P1 | 3.81 | ±0.3 |
| | P2 | 6.35 | ±0.3 |
| Displacement of tape | W2 | 0~0.5 | |

Unit:mm

| Item | Symbol | Standard | Tolerance |
|------------------------------------|--------|----------|--------------|
| Tape width | W | 18.0 | ±0.5 |
| Adhesive tape | W0 | 6.0 | ±0.5 |
| Displacement of perforations | W1 | 9.0 | ±0.5 |
| Work piece bottom surface position | H | 19.0 | +1.0 -0.5 |
| Work piece upper limit position | H1 | 23.5 | ±1.0 |
| Perforations diameter | D0 | φ4.0 | ±0.2 |
| Tape thickness (total thickness) | t | 0.6 | ±0.2 |
| Product inclination | Δc | 0 | ±0.7 |
| Product inclination | Δh | 0 | ±1.0 |

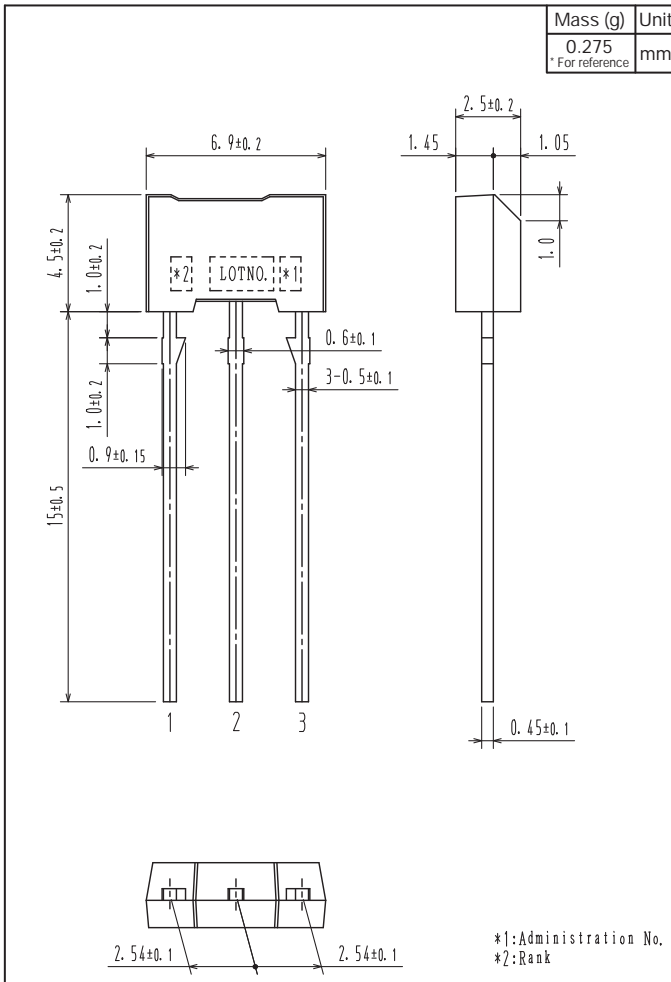
2—3. Taping structure



- Provide an empty section for about three to five pieces in leading and end portions of the tape.
- Provide an empty section in the fold-back portion.
- Provide marking in red to the E-side end of the board.

Outline Drawing

2SA1708S-AN, 2SA1708T-AN, 2SC4488S-AN, 2SC4488T-AN



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